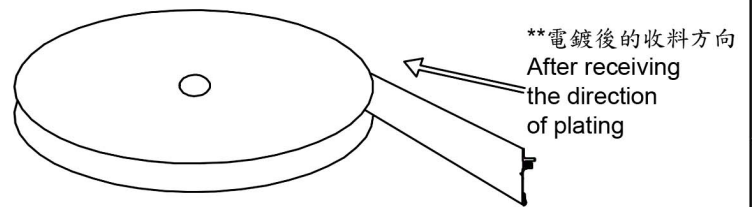
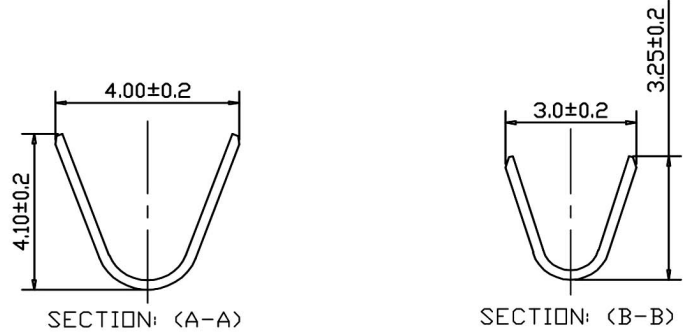


- NOTES:
- MATERIALS: PHOSPHOR BRONZE(C5191-H)
  - BURR: 0.05MAX;WARPAGE: 0.10MAX
  - Wire Range: AWG#18
  - PLATING:
    - (1) BECHICS CLASH AFTER PLATING: 20u\*MIN Ni;80u\*MIN TIN;CONTACT AREA GOLD: 0.5u\* REEK SALT TEST 12H MIN
    - (2) BECHICS CLASH AFTER PLATING: 20u\*MIN Ni;80u\*MIN TIN;CONTACT AREA GOLD: 3u\* REEK SALT TEST 12H MIN
  - LOOSE CONTACT: RETENTION FORCE: 2.5kg MIN
  - REQUIRE : cd≤5ppm pb≤50ppm  
hg≤nd cr≤nd



DIM	TOL	DIM	TOL
X.	/	X*	/
X.X	±0.15	X.X*	±2°
X.XX	±0.10	X.XX*	±1°
X.XXX	±0.05	X.XXX*	/

APPD. 核准	RoHS Compliant	HSM 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.	
DWG. 製圖	Betty	SCALE 比例 參考	PART NAME 品名 1.27mm SATA TERMINAL HIGH TYPE MATERIAL:PHOSPHOR BRONZE SUITABLE FOR 18AWG ROHS
DATE 制表日	2018/03/02	UNIT 單位 M M	PART NO. 料號 T1270-XPA8H0000R
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